- **Designed Specifically for High-Speed Memory Decoders and Data Transmission Systems**

- **Incorporate Three Enable Inputs to Simplify Cascading and/or Data Reception**

- **Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

description

The ′ALS138A and ′AS138 are 3-line to 8-line decoders/demultiplexers designed for high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance systems, these devices can be used to minimize the effects of system decoding. When employed with high-speed memories with a fast enable circuit, the delay times of the decoder and the enable time of the memory are usually less than the typical access time of the memory. The effective system delay introduced by the Schottky-clamped system decoder is negligible.

The conditions at the binary-select (A, B, and C) inputs and the three enable (G1, $\overline{\text{G2A}}$, and $\overline{\text{G2B}}$) inputs select one of eight output lines. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented without external inverters and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

The SN54ALS138A and SN54AS138 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN74ALS138A and SN74AS138 are characterized for operation from 0°C to 70°C.

SN54ALS138A, SN54AS138 . . . J PACKAGE
SN74ALS138A, SN74AS138 . . . D OR N PACKAGE
(TOP VIEW)

A	1	16	V_{CC}
B	2	15	Y0
C	3	14	Y1
$\overline{\text{G2A}}$	4	13	Y2
$\overline{\text{G2B}}$	5	12	Y3
G1	6	11	Y4
Y7	7	10	Y5
GND	8	9	Y6
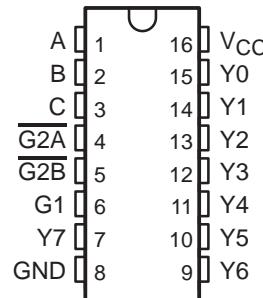
SN54ALS138A, SN54AS138 . . . FK PACKAGE
(TOP VIEW)

Top pins: B(3), A(2), NC(1), V_{CC}(20), Y0(19)

C	4	18	Y1
$\overline{\text{G2A}}$	5	17	Y2
NC	6	16	NC
$\overline{\text{G2B}}$	7	15	Y3
G1	8	14	Y4

Bottom pins: Y7(9), GND(10), NC(11), Y6(12), Y5(13)
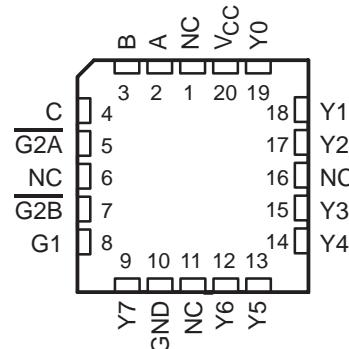
NC – No internal connection

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TEXAS INSTRUMENTS

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

SN54ALS138A, SN54AS138, SN74ALS138A, SN74AS138
3-LINE TO 8-LINE DECODERS/DEMULTIPLEXERS

SDAS055E – APRIL 1982 – REVISED JULY 1996

FUNCTION TABLE

| INPUTS						OUTPUTS							
ENABLE			SELECT										
G1	$\overline{G2A}$	$\overline{G2B}$	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	H	X	X	X	X	H	H	H	H	H	H	H	H
X	X	H	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	L	H	H	L	H	H	H	H	H	H
H	L	L	L	H	L	H	H	L	H	H	H	H	H
H	L	L	L	H	H	H	H	H	L	H	H	H	H
H	L	L	H	L	L	H	H	H	H	L	H	H	H
H	L	L	H	L	H	H	H	H	H	H	L	H	H
H	L	L	H	H	L	H	H	H	H	H	H	L	H
H	L	L	H	H	H	H	H	H	H	H	H	H	L

logic symbols (alternatives)†
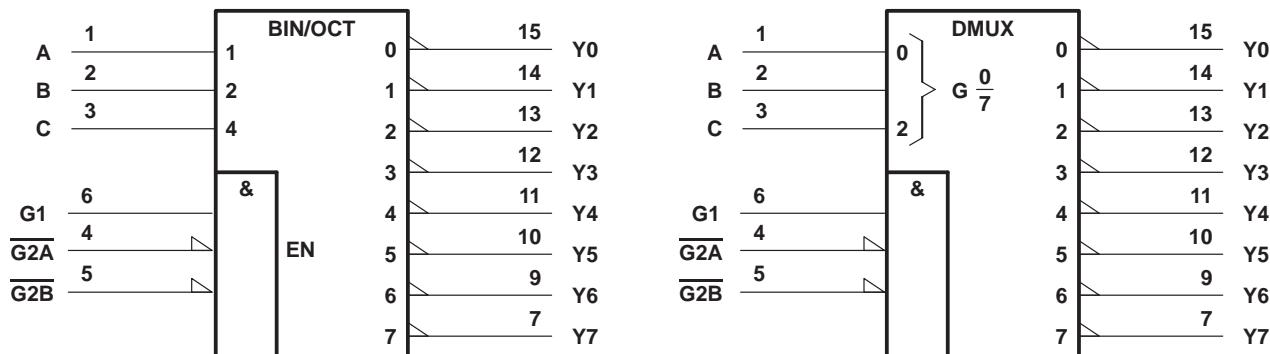
† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)

Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} .... 7 V
Input voltage, V_I .... 7 V
Operating free-air temperature range, T_A: SN54ALS138A .... −55°C to 125°C
SN74ALS138A .... 0°C to 70°C
Storage temperature range, T_{stg} .... −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS138A			SN74ALS138A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS138A			SN74ALS138A			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	$V_{CC} = 4.5$ V,	$I_I = -18$ mA			−1.5			−1.5	V
V_{OH}	$V_{CC} = 4.5$ V,	$I_{OH} = -0.4$ mA	$V_{CC} -2$			$V_{CC} -2$			V
V_{OL}	$V_{CC} = 4.5$ V	$I_{OL} = 4$ mA		0.25	0.4		0.25	0.4	V
		$I_{OL} = 8$ mA					0.35	0.5	
I_I	$V_{CC} = 5.5$ V,	$V_I = 7$ V			0.1			0.1	mA
I_{IH}	$V_{CC} = 5.5$ V,	$V_I = 2.7$ V			20			20	μA
I_{IL}	$V_{CC} = 5.5$ V,	$V_I = 0.4$ V			−0.1			−0.1	mA
I_O§	$V_{CC} = 5.5$ V,	$V_O = 2.25$ V	−20		−112	−30		−112	mA
I_{CC}	$V_{CC} = 5.5$ V			5	10		5	10	mA

‡ All typical values are at $V_{CC} = 5$ V, $T_A = 25$°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ V to 5.5 V, $C_L = 50$ pF, $R_L = 500\ \Omega$, $T_A = $ MIN to MAX¶				UNIT
			SN54ALS138A		SN74ALS138A		
			MIN	MAX	MIN	MAX	
t_{PLH}	A, B, C	Any Y	2	28	5	22	ns
t_{PHL}			6	22	6	18	
t_{PLH}	G or $\overline{G}$	Any Y	2	22	3	17	ns
t_{PHL}			4	21	4	17	

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} .... 7 V
Input voltage, V_I .... 7 V
Operating free-air temperature range, T_A: SN54AS138 .... −55°C to 125°C
SN74AS138 .... 0°C to 70°C
Storage temperature range, T_{stg} .... −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS138			SN74AS138			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−2			−2	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54AS138			SN74AS138			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = −18 mA			−1.2			−1.2	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = −2 mA	V_{CC} −2			V_{CC} −2			V
V_{OL}	V_{CC} = 4.5 V,	I_{OL} = 20 mA		0.35	0.5		0.35	0.5	V
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	μA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.5			−0.5	mA
I_O§	V_{CC} = 5.5 V,	V_O = 2.25 V	−30		−112	−30		−112	mA
I_{CCH}	V_{CC} = 5.5 V			12	17.5		12	17.5	mA
I_{CCL}	V_{CC} = 5.5 V			14	20		14	20	mA

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX†				UNIT
			SN54AS138		SN74AS138		
			MIN	MAX	MIN	MAX	
t_{PLH}	A, B, C	Any Y	2	11	2	10	ns
t_{PHL}			2	11	2	9.5	
t_{PLH}	G1	Any Y	2	11.5	2	10	ns
t_{PHL}			2	11	2	10	
t_{PLH}	$\overline{G2}$	Any Y	2	9	2	7.5	ns
t_{PHL}			2	10	2	8.5	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES

**LOAD CIRCUIT FOR
BI-STATE
TOTEM-POLE OUTPUTS**

**LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS**

**LOAD CIRCUIT
FOR 3-STATE OUTPUTS**

$R_L = R1 = R2$

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PULSE DURATIONS**

**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**
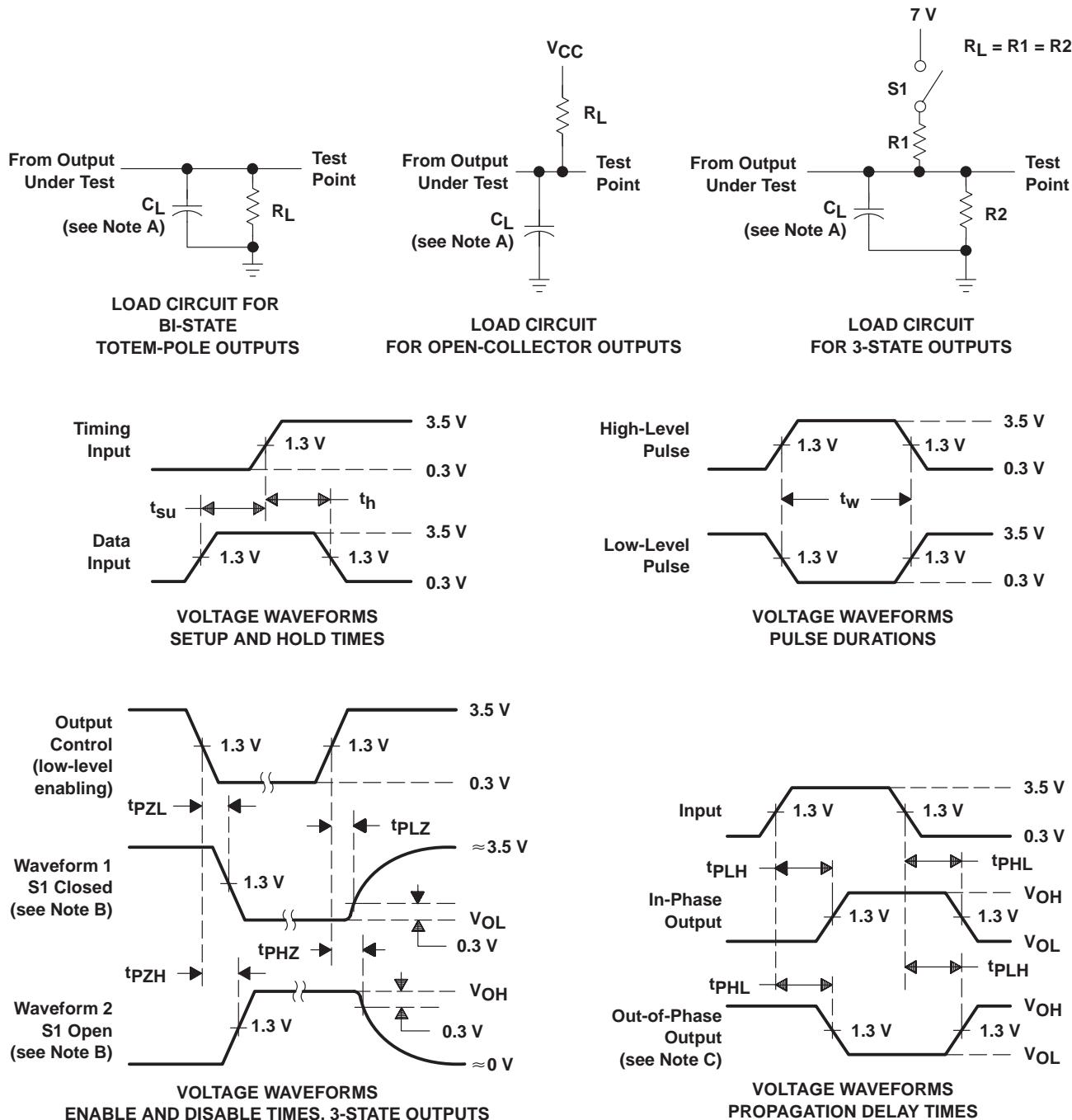
NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
   Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

**TEXAS
INSTRUMENTS**

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-86866012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-86866012A SNJ54ALS 138AFK	Samples
5962-8686601FA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8686601FA SNJ54ALS138AW	Samples
JM38510/37701B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type		JM38510/ 37701B2A	Samples
JM38510/37701BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type		JM38510/ 37701BEA	Samples
M38510/37701B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 37701B2A	Samples
M38510/37701BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 37701BEA	Samples
SN54ALS138AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type		SN54ALS138AJ	Samples
SN54AS138J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54AS138J	Samples
SN74ALS138AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS138A	Samples
SN74ALS138ADE4	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS138A	Samples
SN74ALS138ADG4	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS138A	Samples
SN74ALS138ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS138A	Samples
SN74ALS138ADRG4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS138A	Samples
SN74ALS138AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS138AN	Samples
SN74ALS138ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS138A	Samples
SN74AS138D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS138	Samples
SN74AS138N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS138N	Samples

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AS138NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS138	Samples
SNJ54ALS138AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-86866012A SNJ54ALS 138AFK	Samples
SNJ54ALS138AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54ALS138AJ	Samples
SNJ54ALS138AW	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8686601FA SNJ54ALS138AW	Samples
SNJ54AS138FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54AS 138FK	Samples
SNJ54AS138J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54AS138J	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54ALS138A, SN54AS138, SN74ALS138A, SN74AS138 :

• Catalog : SN74ALS138A, SN74AS138

• Military : SN54ALS138A, SN54AS138

NOTE: Qualified Version Definitions:

> • Catalog - TI's standard catalog product

> • Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS
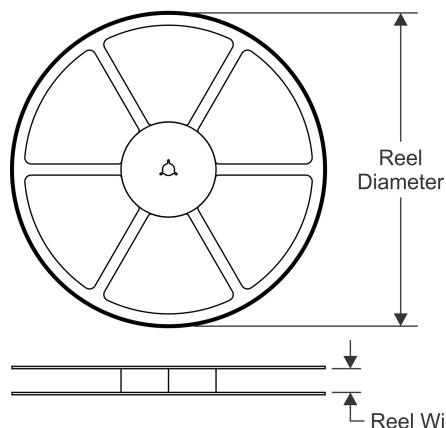
TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE
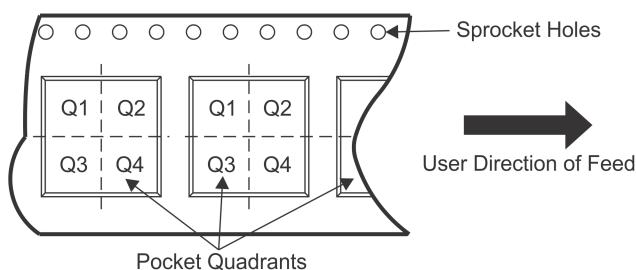
*All dimensions are nominal

| Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS138ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74ALS138ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74AS138NSR	SO	NS	16	2000	330.0	16.4	8.45	10.55	2.5	12.0	16.2	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS138ADR	SOIC	D	16	2500	340.5	336.1	32.0
SN74ALS138ANSR	SO	NS	16	2000	853.0	449.0	35.0
SN74AS138NSR	SO	NS	16	2000	853.0	449.0	35.0

TUBE
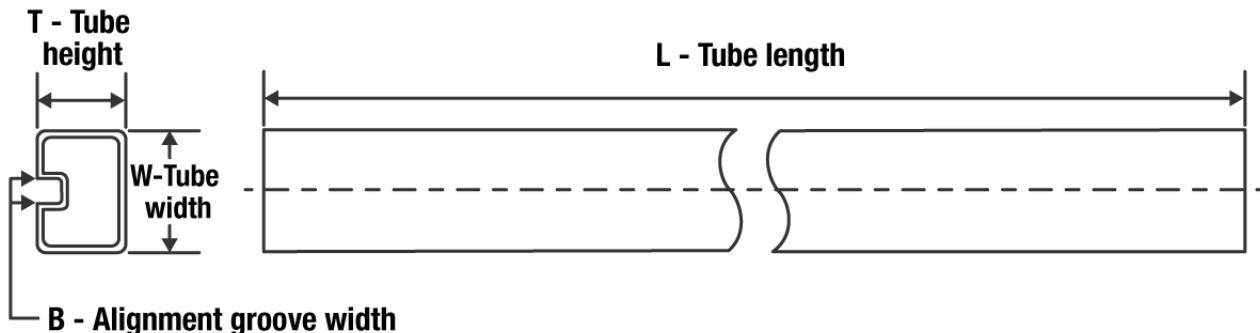
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-86866012A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/37701B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/37701B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
SN74ALS138AD	D	SOIC	16	40	507	8	3940	4.32
SN74ALS138ADE4	D	SOIC	16	40	507	8	3940	4.32
SN74ALS138ADG4	D	SOIC	16	40	507	8	3940	4.32
SN74ALS138AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS138AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS138D	D	SOIC	16	40	507	8	3940	4.32
SN74AS138N	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS138N	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54ALS138AFK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54AS138FK	FK	LCCC	20	1	506.98	12.06	2030	NA

W (R−GDFP−F16)   CERAMIC DUAL FLATPACK

Base and Seating Plane

$\frac{0.045\ (1,14)}{0.026\ (0,66)}$

$\frac{0.285\ (7,24)}{0.245\ (6,22)}$

$\frac{0.080\ (2,03)}{0.055\ (1,40)}$

$\frac{0.008\ (0,20)}{0.004\ (0,10)}$

0.305 (7,75) MAX

1   16

$\frac{0.019\ (0,48)}{0.015\ (0,38)}$

$\frac{0.430\ (10,92)}{0.370\ (9,40)}$

0.050 (1,27)

0.005 (0,13) MIN
4 Places

8   9

$\frac{0.360\ (9,14)}{0.250\ (6,35)}$ $\frac{0.360\ (9,14)}{0.250\ (6,35)}$
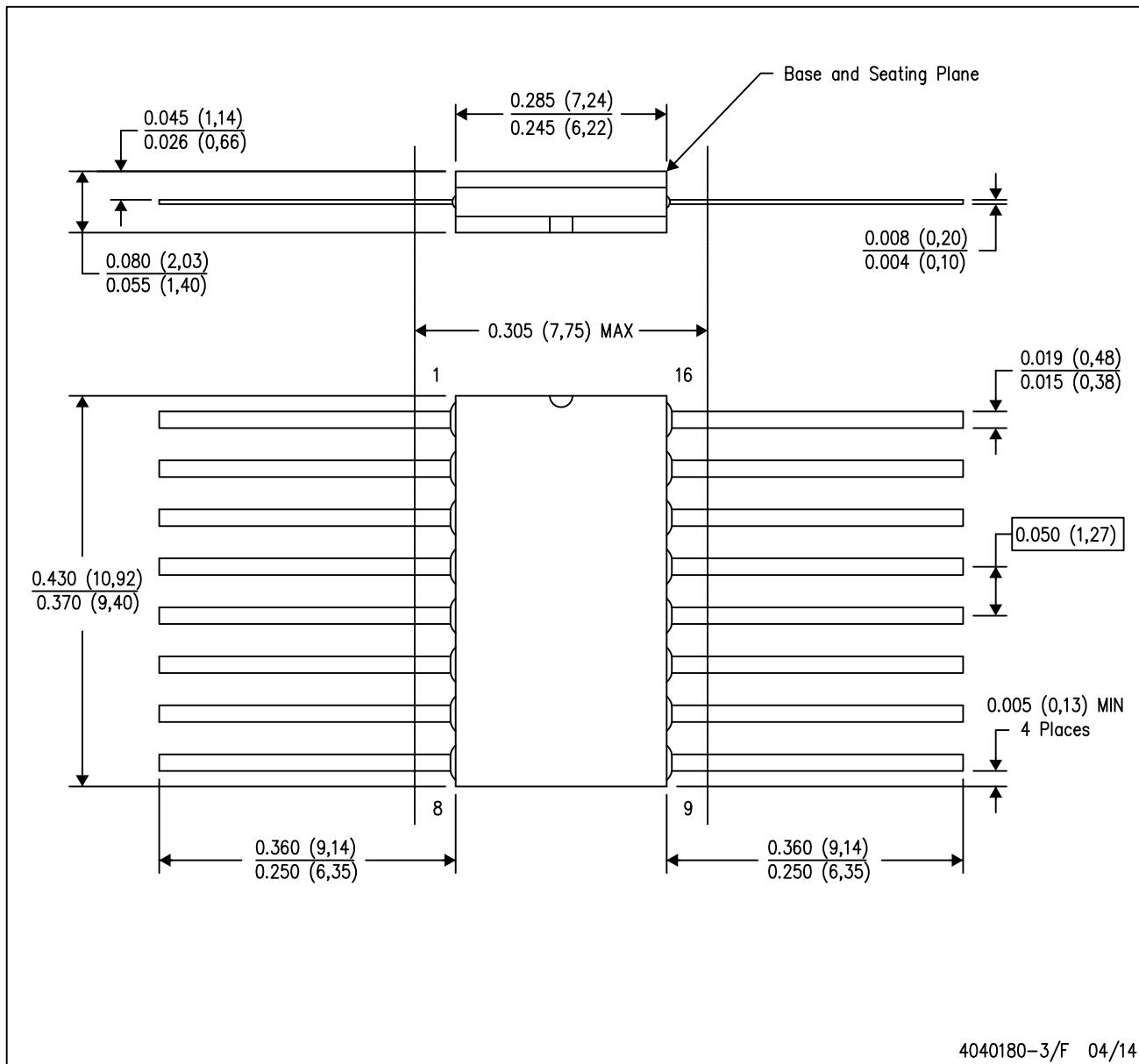
4040180−3/F 04/14

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
         C. This package can be hermetically sealed with a ceramic lid using glass frit.
         D. Index point is provided on cap for terminal identification only.
         E. Falls within MIL STD 1835 GDFP2−F16
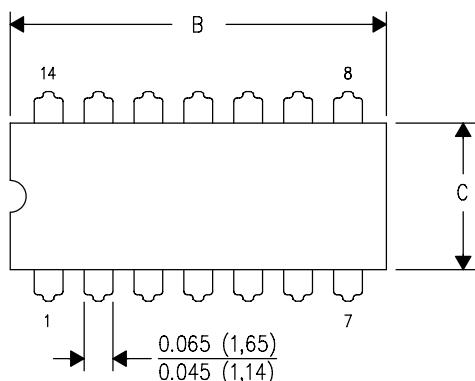
DIM / PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	——	——	——	——
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

B

14   8

C

1   7

0.065 (1,65)
0.045 (1,14)

0.005 (0,13) MIN

0.060 (1,52)
0.015 (0,38)

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

0.026 (0,66)
0.014 (0,36)

0.100 (2,54)

A

0°–15°

0.014 (0,36)
0.008 (0,20)
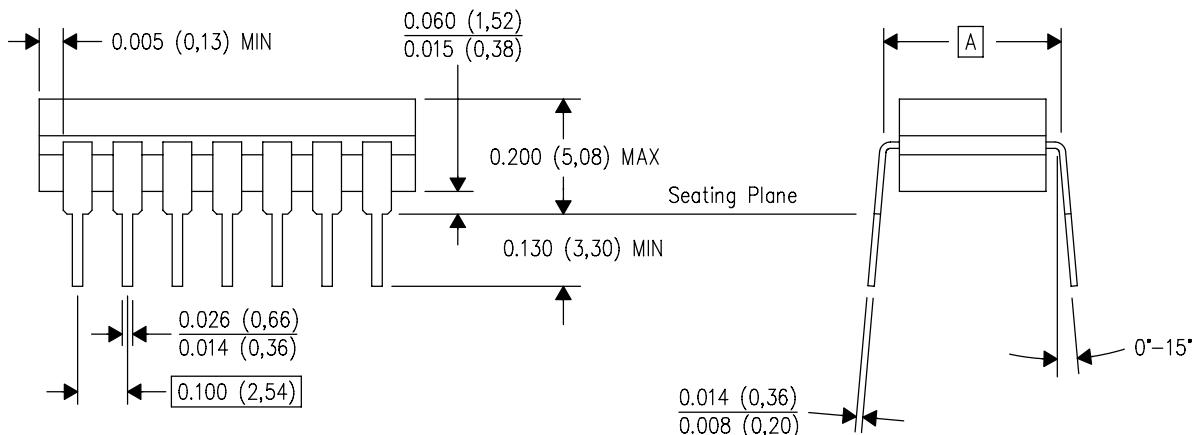
4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
         C. This package is hermetically sealed with a ceramic lid using glass frit.
         D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
         E. Falls within MIL STD 1835 GDIP1—T14, GDIP1—T16, GDIP1—T18 and GDIP1—T20.

N (R−PDIP−T**)

16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE

DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

△C

0.260 (6,60) / 0.240 (6,10)

0.070 (1,78) / 0.045 (1,14) △D

0.045 (1,14) / 0.030 (0,76) △D

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53) / 0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

14/18 Pin Only
20 Pin vendor option △D

0.325 (8,26) / 0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX

4040049/E   12/2002

NOTES: A.   All linear dimensions are in inches (millimeters).
   B.   This drawing is subject to change without notice.
   △C   Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
   △D   The 20 pin end lead shoulder width is a vendor option, either half or full width.

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C

SEATING PLANE

⌒ 0.1 C

8.2 / 7.4 TYP

A

PIN 1 ID AREA

14X 1.27

1

16

10.4 / 10.0 NOTE 3

2X 8.89

8

9

16X 0.51 / 0.35

⊕ 0.25Ⓜ C A B

B

5.4 / 5.2 NOTE 4

2.00 MAX

SEE DETAIL A

0.15 TYP

0.25

GAGE PLANE

0.3 / 0.1

0° - 10°

1.05 / 0.55

(1.25)

DETAIL A
TYPICAL

4220735/A   12/2021

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

16X (1.85)

SYMM
℄

SEE
DETAILS

1

16

16X (0.6)

SYMM
℄

14X (1.27)

8

9

(R0.05) TYP

(7)
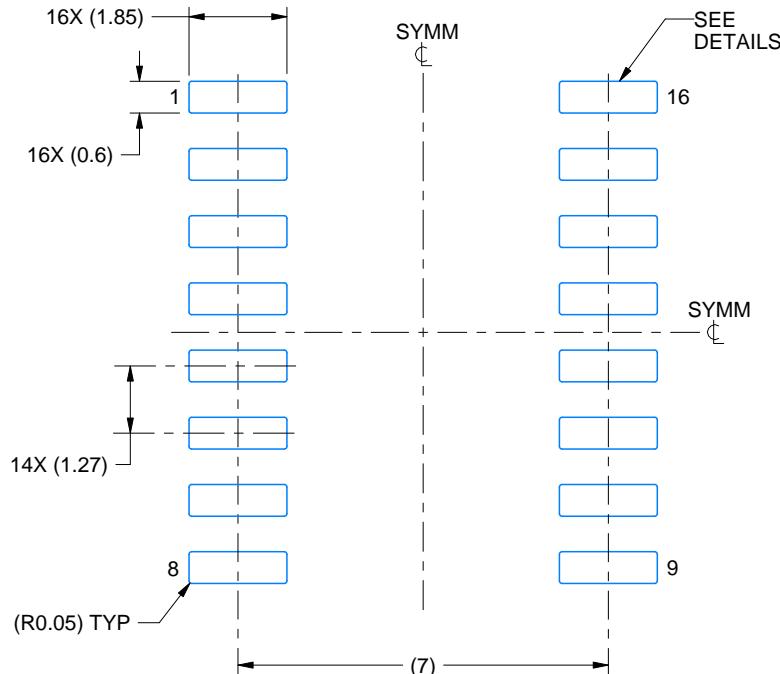
LAND PATTERN EXAMPLE
SCALE:7X

METAL

SOLDER MASK
OPENING

SOLDER MASK
OPENING

METAL

0.07 MAX
ALL AROUND

0.07 MIN
ALL AROUND

NON SOLDER MASK
DEFINED

SOLDER MASK
DEFINED
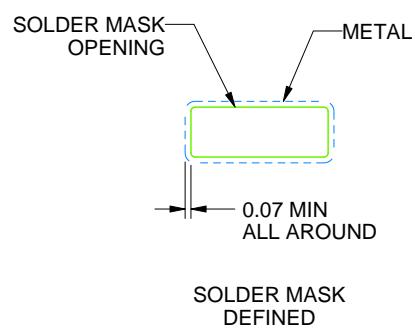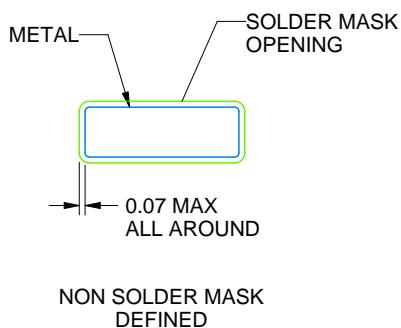
SOLDER MASK DETAILS

4220735/A   12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

16X (1.85)

SYMM

1

16X (0.6)

16

SYMM

14X (1.27)

8

9

(R0.05) TYP

(7)
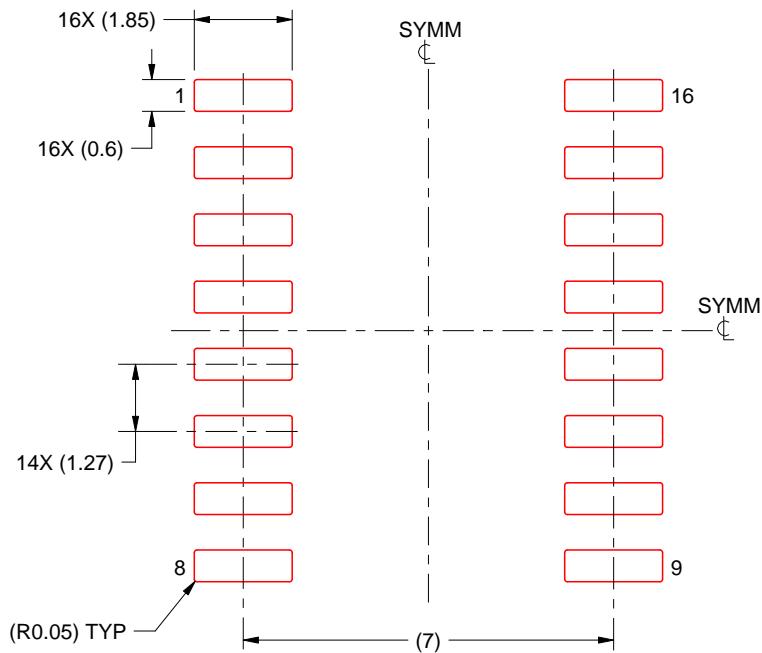
SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220735/A   12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

FK (S−CQCC−N**)　　　　　　　　LEADLESS CERAMIC CHIP CARRIER
28 TERMINAL SHOWN
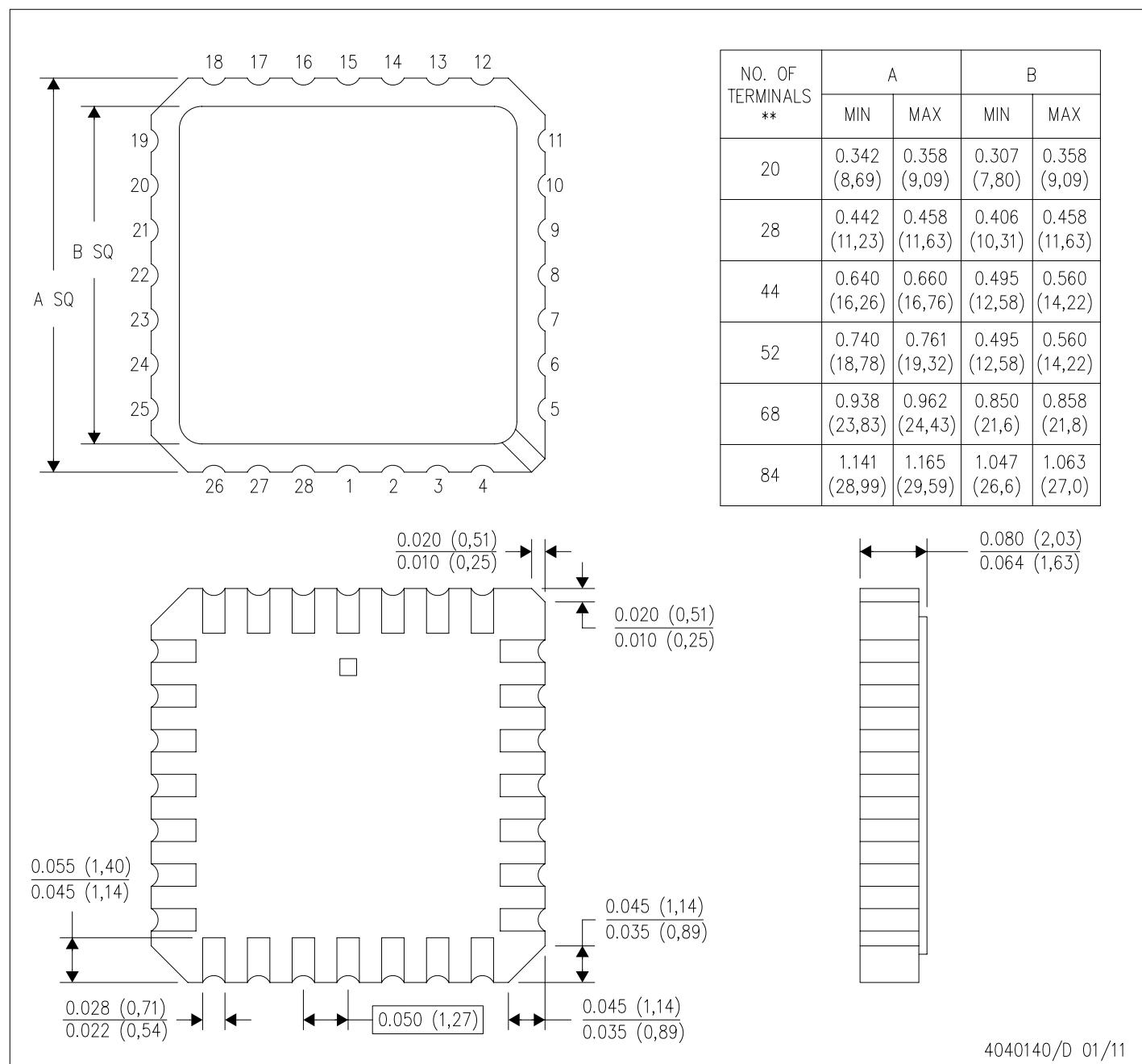
NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

$\frac{0.020\ (0,51)}{0.010\ (0,25)}$

$\frac{0.020\ (0,51)}{0.010\ (0,25)}$

$\frac{0.080\ (2,03)}{0.064\ (1,63)}$

$\frac{0.055\ (1,40)}{0.045\ (1,14)}$

$\frac{0.045\ (1,14)}{0.035\ (0,89)}$

$\frac{0.028\ (0,71)}{0.022\ (0,54)}$　　0.050 (1,27)　　$\frac{0.045\ (1,14)}{0.035\ (0,89)}$

4040140/D 01/11

NOTES:　A.　All linear dimensions are in inches (millimeters).
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　This package can be hermetically sealed with a metal lid.
　　　　　D.　Falls within JEDEC MS−004
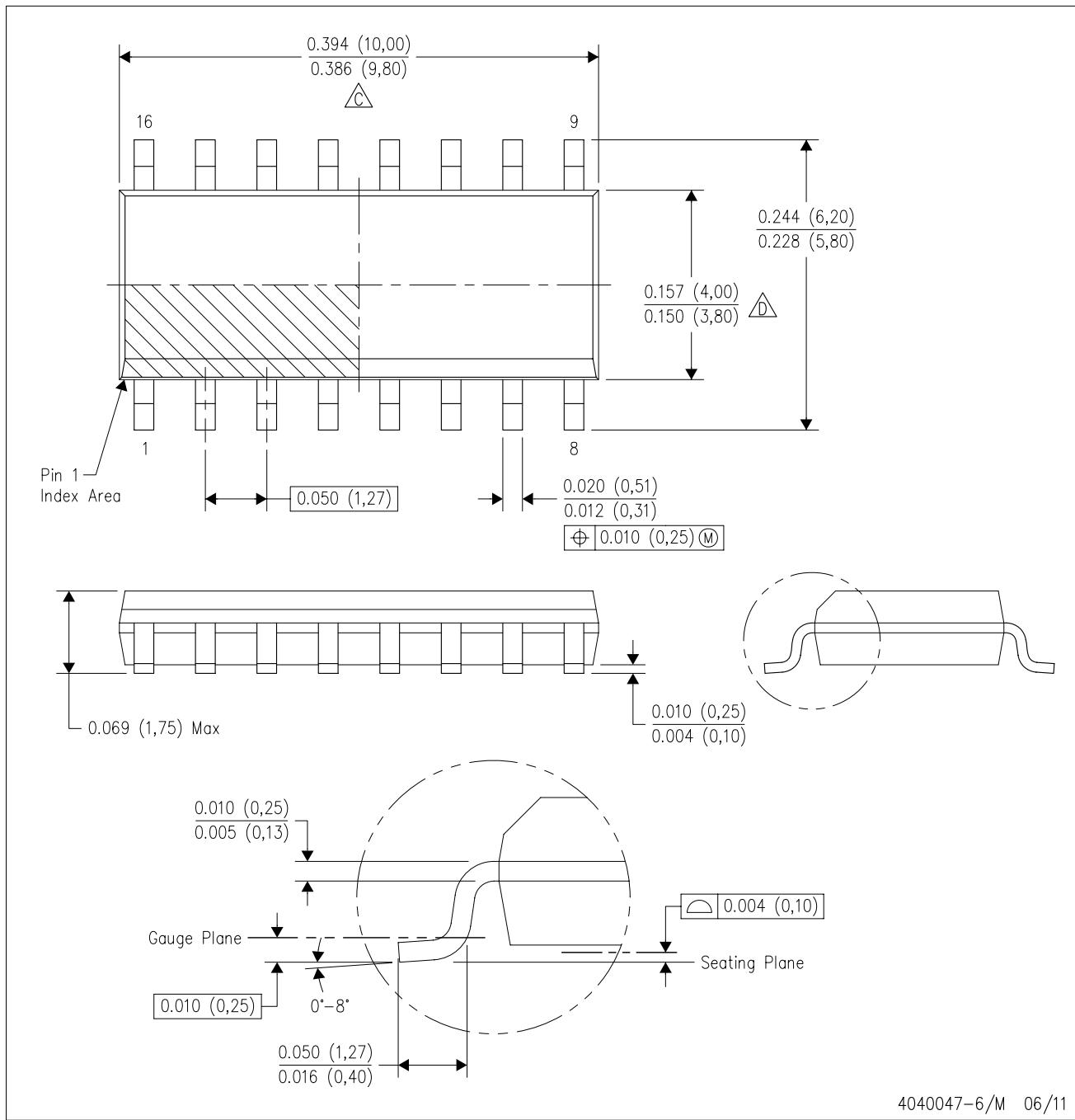
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D (R−PDSO−G16)   PLASTIC SMALL OUTLINE

0.394 (10,00)
0.386 (9,80)
⟨C⟩

16   9

0.244 (6,20)
0.228 (5,80)

0.157 (4,00)
0.150 (3,80) ⟨D⟩

1   8

Pin 1
Index Area

0.050 (1,27)

0.020 (0,51)
0.012 (0,31)

⊕ 0.010 (0,25) Ⓜ

0.069 (1,75) Max

0.010 (0,25)
0.004 (0,10)

0.010 (0,25)
0.005 (0,13)

⌂ 0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)   0°−8°

0.050 (1,27)
0.016 (0,40)

4040047−6/M   06/11

NOTES: A. All linear dimensions are in inches (millimeters).
         B. This drawing is subject to change without notice.
     ⟨C⟩ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall
          not exceed 0.006 (0,15) each side.
     ⟨D⟩ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
         E. Reference JEDEC MS−012 variation AC.

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D (R−PDSO−G16)   PLASTIC SMALL OUTLINE

Example Board Layout
(Note C)

Stencil Openings
(Note D)

←14x1,27

16x0,55

14x1,27

16x1,50

5,40

5.40
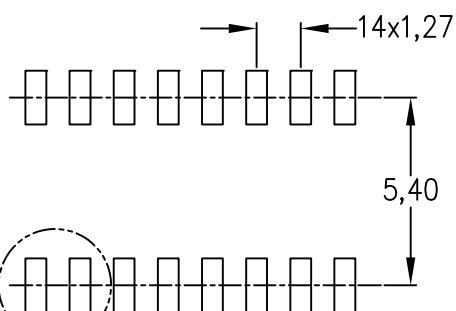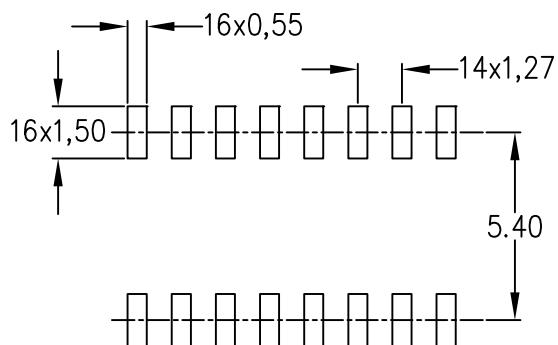
Example
Non Soldermask Defined Pad
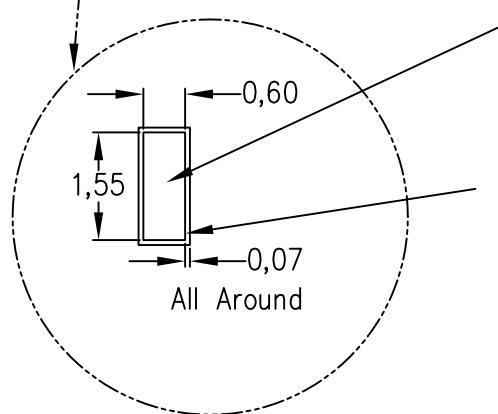
Example
Pad Geometry
(See Note C)

─0,60

1,55

Example
Solder Mask Opening
(See Note E)

─0,07

All Around

4211283−4/E 08/12

NOTES: A. All linear dimensions are in millimeters.
         B. This drawing is subject to change without notice.
         C. Publication IPC−7351 is recommended for alternate designs.
         D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should
             contact their board assembly site for stencil design recommendations. Refer to IPC−7525 for other stencil recommendations.
         E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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MECHANICAL DATA

	PINS **	14	16	20	24
DIM					
A MAX		10,50	10,50	12,90	15,30
A MIN		9,90	9,90	12,30	14,70

4040062/C 03/03
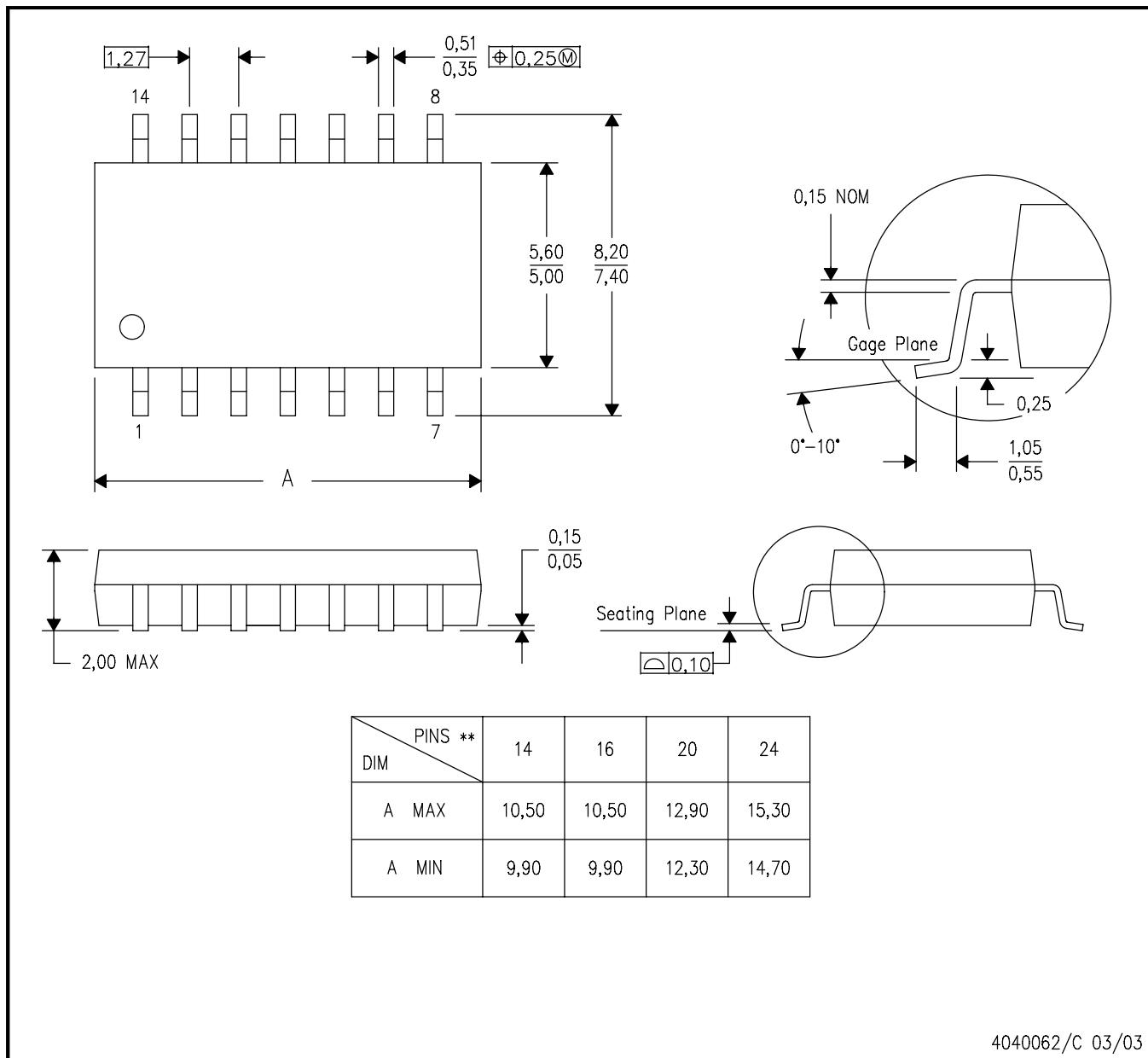
NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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